





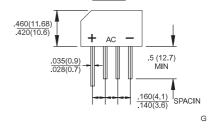
Features

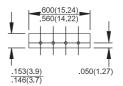
- ♦ UL Recognized File # E-96005
- ♦ Glass passivated junction
- ♦ Ideal for printed circuit board
- Reliable low cost construction technique results in inexpensive product
- High temperature soldering guaranteed: 260 °C / 10 seconds at 5 lbs. (2.3 Kg) tension
- Small size, simple installation Leads solderable per MIL-STD-202, Method 208
- Green compound with suffix "G" on packing code & prefix "G" on datecode.

KBP201G - KBP207G

Single Phase 2.0 AMPS. Glass Passivated Bridge Rectifiers

KBP





Dimensions in inches and (millimeters)

Marking Diagram



KBP20XG = Specific Device Code
G = Green Compound
Y = Year
WW = Work Week

Maximum Ratings and Electrical Characteristics

Rating at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%

Type Number	Symbol	KBP 201G	KBP 202G	KBP 203G	KBP 204G	KBP 205G	KBP 206G	KBP 207G	Units
Maximum Recurrent Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current $@T_A = 50$ °C	I(AV)	2.0							Α
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I FSM	60							А
Rating for Fusing (t<8.35ms)	I ² t	15							A ² sec
Maximum Instantaneous Forward Voltage @ 3.14A	VF	1.2							V
Maximum DC Reverse Current @ T_A =25 °C at Rated DC Blocking Voltage @ T_A =125 °C	I R	10 500						uA uA	
Typical thermal resistance (Note)	Reja Rejl	25 8							°C/W
Operating Temperature Range	Тл	-55 to +150							°C
Storage Temperature Range	Тѕтс	-55 to +150							°C

Note: Thermal Resistance from Junction to Ambient and from Junction to Lead Mounted on P.C.B.

With 0.4" x 0.4" (10 x 10mm) Copper Pads.

Version: B08



RATINGS AND CHARACTERISTIC CURVES (KBP201G THRU KBP207G)

